PCN Number:		20130722002						PCN Dat	e:	07/23/2013	
Title:	TPS71501-Q	datasheet - CMS C1307004									
<b>Customer Contact:</b>		PCN	PCN Manager		Phone:	+1(214) 480-6037		7 Dept:	Quality Services		
Change Type:											
Assembly Site			Assembly Process				Assembly Materials				
Design				Electrical Specification				Mechanical Specification			
Test Site				Packing/Shipping/Labeling				Test Process			
Wafer Bump Site			<u>Ц</u>	Wafer Bump Material			<u> </u>	Wafer Bump Process			
Wafer Fab Site				Wafer Fab Materials				Wafer Fab Process			
PCN Details											
Description of Change:											
Texas Instruments publication SGLS272F will change as described below:											
Page 3, Electrical Characteristics table, define Output Current limit test conditions for both $V_{\text{IN}} \ge 3.5 \text{V}$ and $<3.5 \text{V}$ .											
Reason for Change:											
Update datasheet to reflect the current limit test conditions.											
Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):											
No anticipated impact. This is a specification change announcement only. There are no changes to the actual devices.											
Changes to product identification resulting from this PCN:											
None											
Product Affected:											
TPS71501QDCKRQ1 TPS71525QDCKRQ1 TPS71530QDCKRQ1 TPS71533QDCKRQ1 TPS71550QDCKRQ1											

For questions regarding this notice, e-mails can be sent to the regional contacts shown below or your local Field Sales Representative.

Location	E-Mail
USA	PCNAmericasContact@list.ti.com
Europe	PCNEuropeContact@list.ti.com
Asia Pacific	PCNAsiaContact@list.ti.com
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